

# STARPOWER

## SEMICONDUCTOR

## IGBT

# GD200HFX170C2S

**1700V/200A 2 in one-package**

## General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

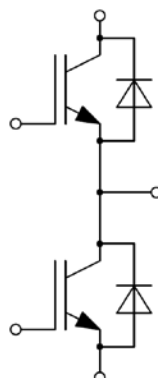
## Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

## Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

## Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
$V_{CES}$	Collector-Emitter Voltage	1700	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=100^{\circ}\text{C}$	337 200	A
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	400	A
$P_D$	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	1271	W

**Diode**

Symbol	Description	Values	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	1700	V
$I_F$	Diode Continuous Forward Current	200	A
$I_{FM}$	Diode Maximum Forward Current $t_p=1\text{ms}$	400	A

**Module**

Symbol	Description	Values	Unit
$T_{jmax}$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{jop}$	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	4000	V

**IGBT Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.85	2.20	V
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=125^{\circ}\text{C}$		2.25		
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		2.35		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=8.00\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.6	6.2	6.8	V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			5.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			400	nA
$R_{Gint}$	Internal Gate Resistance			3.8		$\Omega$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		24.1		nF
$C_{res}$	Reverse Transfer Capacitance			0.58		nF
$Q_G$	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		1.89		$\mu\text{C}$
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=200\text{A}, R_G=3.6\Omega, V_{GE}=\pm 15\text{V}, T_j=25^{\circ}\text{C}$		204		ns
$t_r$	Rise Time			48		ns
$t_{d(off)}$	Turn-Off Delay Time			595		ns
$t_f$	Fall Time			100		ns
$E_{on}$	Turn-On Switching Loss			58.3		mJ
$E_{off}$	Turn-Off Switching Loss			40.3		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=200\text{A}, R_G=3.6\Omega, V_{GE}=\pm 15\text{V}, T_j=125^{\circ}\text{C}$		224		ns
$t_r$	Rise Time			55		ns
$t_{d(off)}$	Turn-Off Delay Time			611		ns
$t_f$	Fall Time			159		ns
$E_{on}$	Turn-On Switching Loss			81.0		mJ
$E_{off}$	Turn-Off Switching Loss			62.7		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=200\text{A}, R_G=3.6\Omega, V_{GE}=\pm 15\text{V}, T_j=150^{\circ}\text{C}$		240		ns
$t_r$	Rise Time			55		ns
$t_{d(off)}$	Turn-Off Delay Time			624		ns
$t_f$	Fall Time			180		ns
$E_{on}$	Turn-On Switching Loss			88.6		mJ
$E_{off}$	Turn-Off Switching Loss			67.2		mJ
$I_{SC}$	SC Data	$t_P \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}, V_{CC}=1000\text{V}, V_{CEM} \leq 1700\text{V}$		800		A

**Diode Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_F$	Diode Forward Voltage	$I_F=200\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.80	2.25	V
		$I_F=200\text{A}, V_{GE}=0\text{V}, T_j=125^{\circ}\text{C}$		1.90		
		$I_F=200\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.95		
$Q_r$	Recovered Charge	$V_R=900\text{V}, I_F=200\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^{\circ}\text{C}$		55.0		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			220		A
$E_{rec}$	Reverse Recovery Energy			26.5		mJ
$Q_r$	Recovered Charge	$V_R=900\text{V}, I_F=200\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^{\circ}\text{C}$		93.5		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			252		A
$E_{rec}$	Reverse Recovery Energy			52.9		mJ
$Q_r$	Recovered Charge	$V_R=900\text{V}, I_F=200\text{A},$ $-di/dt=3520\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^{\circ}\text{C}$		99.0		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current			260		A
$E_{rec}$	Reverse Recovery Energy			60.0		mJ

**Module Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
$L_{CE}$	Stray Inductance			20	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.35		m $\Omega$
$R_{thJC}$	Junction-to-Case (per IGBT)			0.118	K/W
	Junction-to-Case (per Diode)			0.159	
$R_{thCH}$	Case-to-Heatsink (per IGBT)		0.035		K/W
	Case-to-Heatsink (per Diode)		0.047		
	Case-to-Heatsink (per Module)		0.010		
M	Terminal Connection Torque, Screw M6	2.5		5.0	N.m
	Mounting Torque, Screw M6	3.0		5.0	
G	Weight of Module		300		g

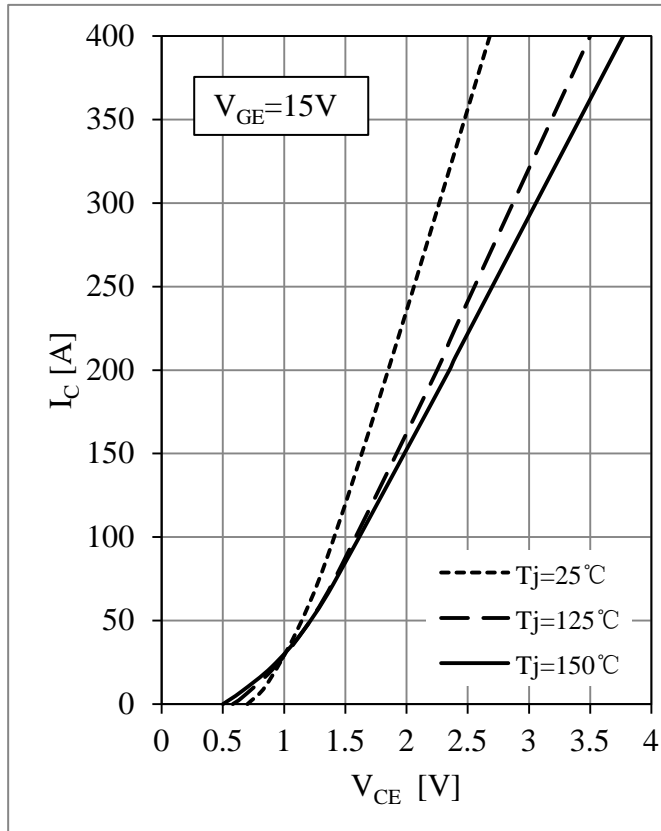


Fig 1. IGBT Output Characteristics

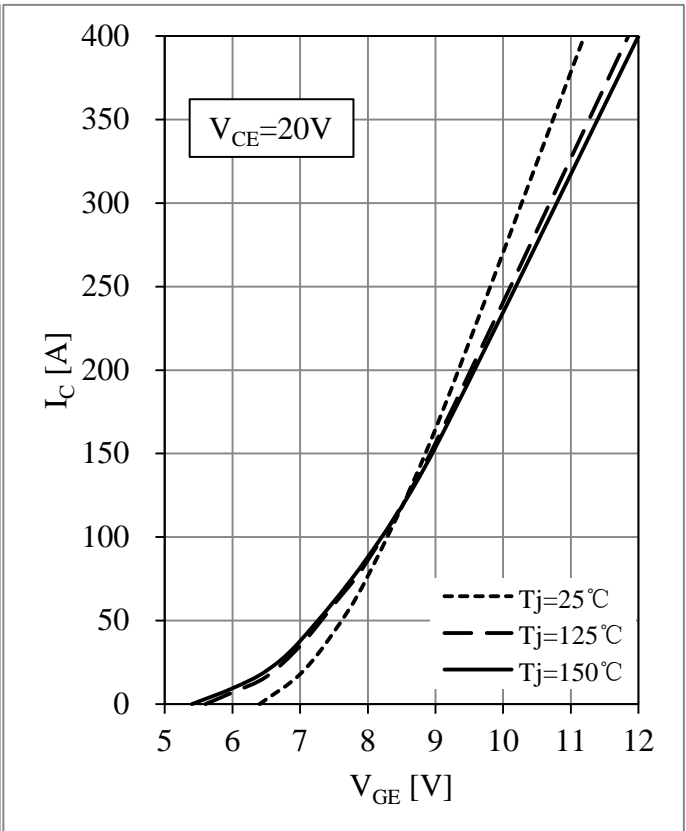
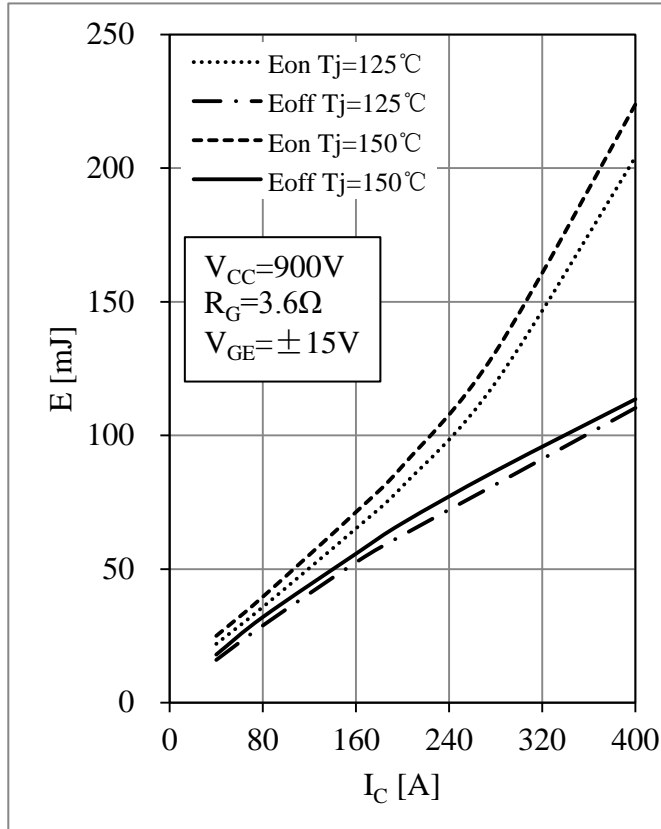
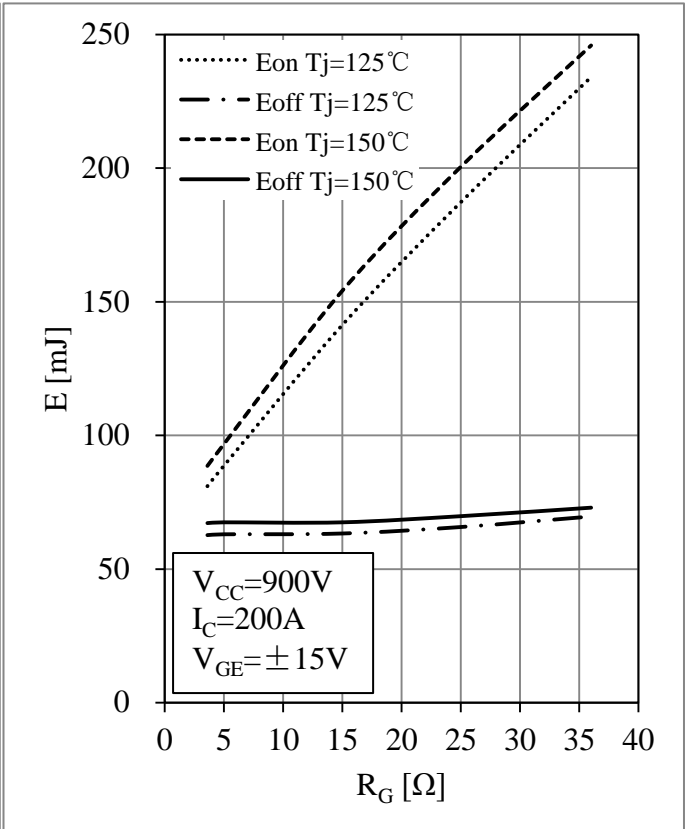


Fig 2. IGBT Transfer Characteristics

Fig 3. IGBT Switching Loss vs.  $I_C$ Fig 4. IGBT Switching Loss vs.  $R_G$

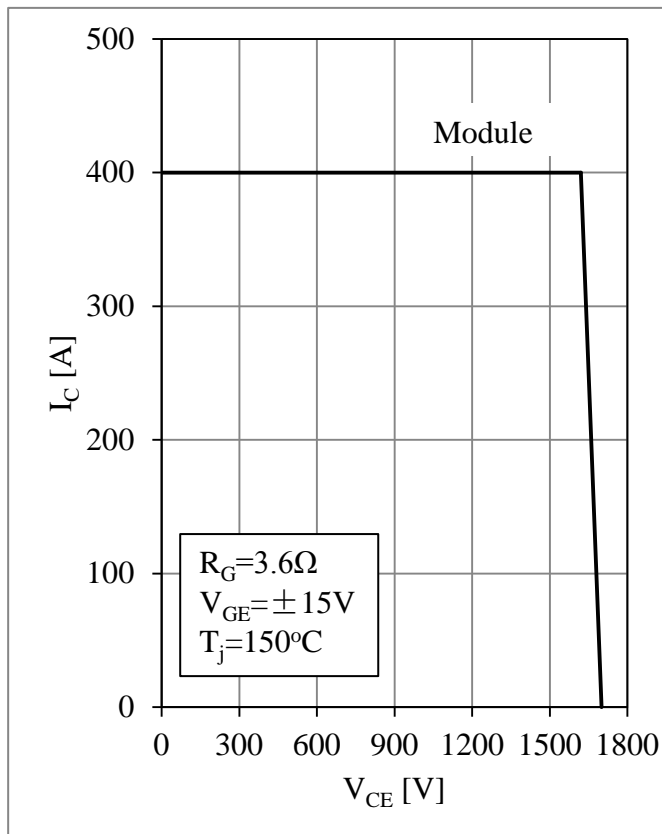


Fig 5. RBSOA

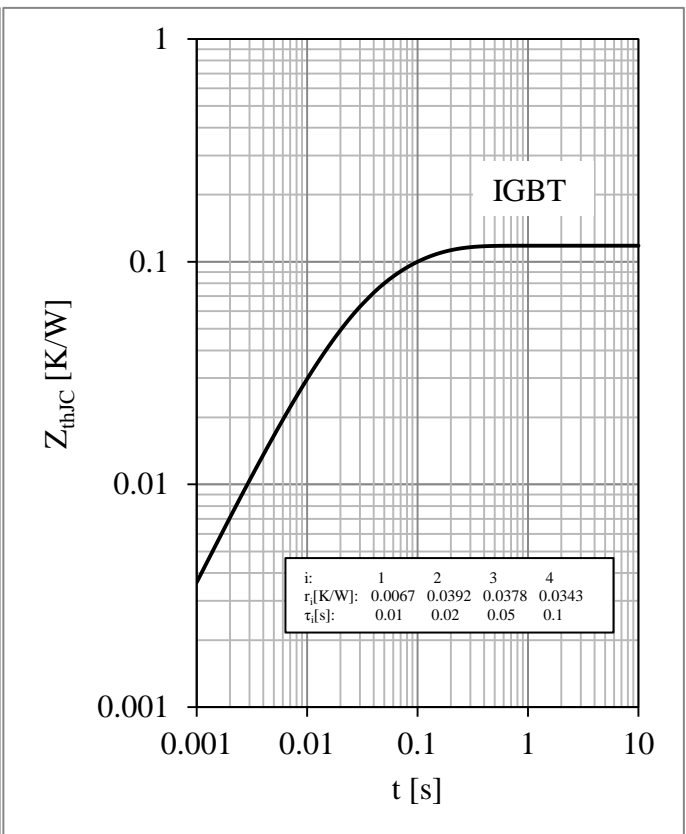


Fig 6. IGBT Transient Thermal Impedance

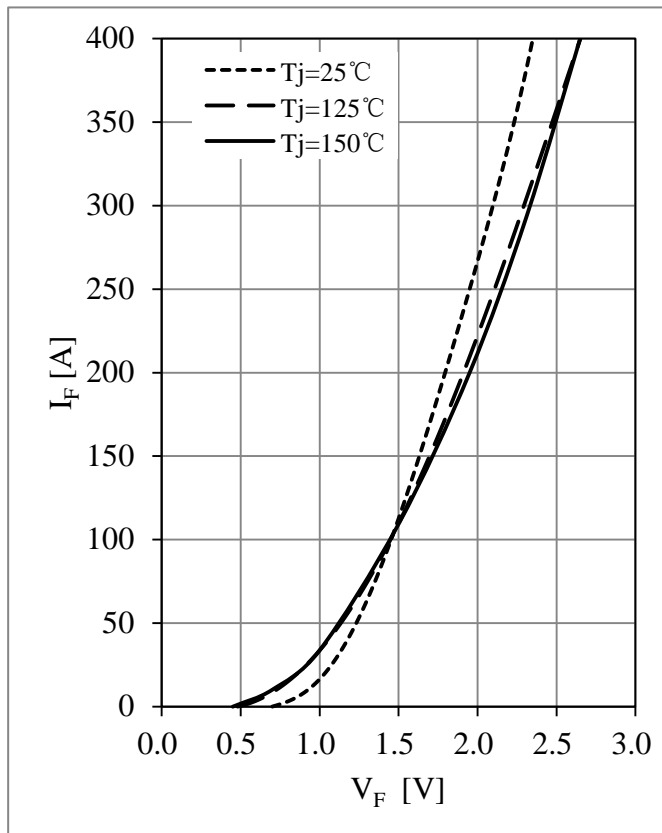
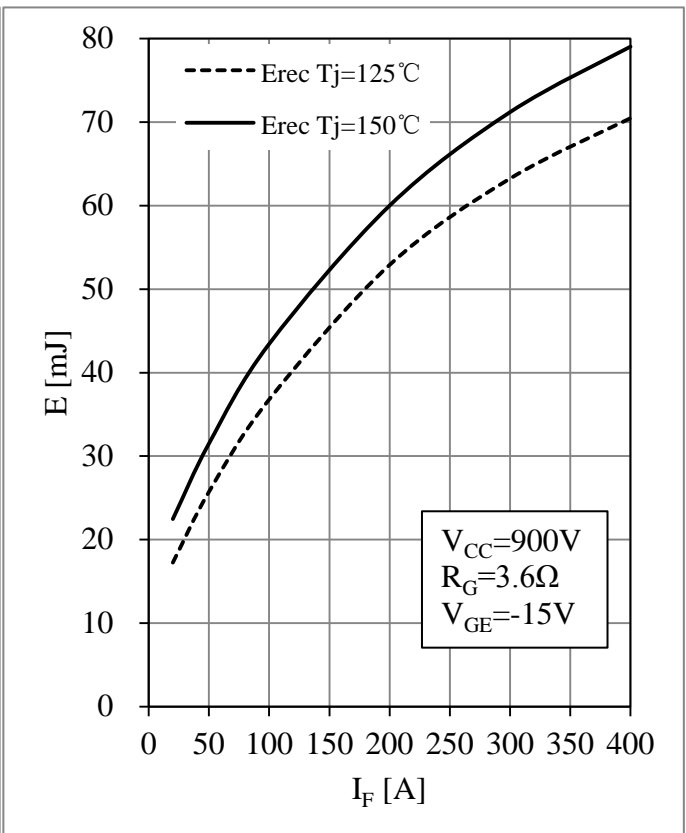


Fig 7. Diode Forward Characteristics

Fig 8. Diode Switching Loss vs.  $I_F$

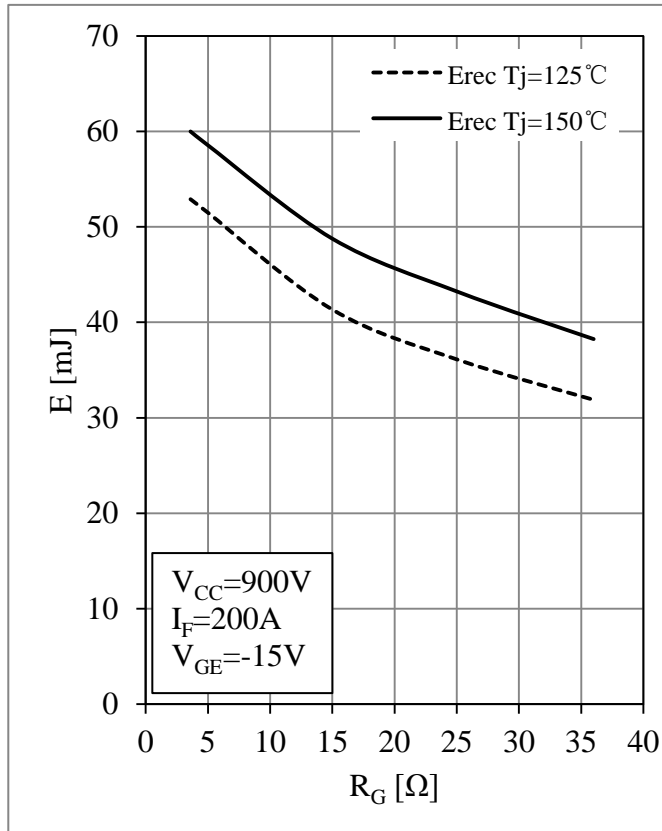
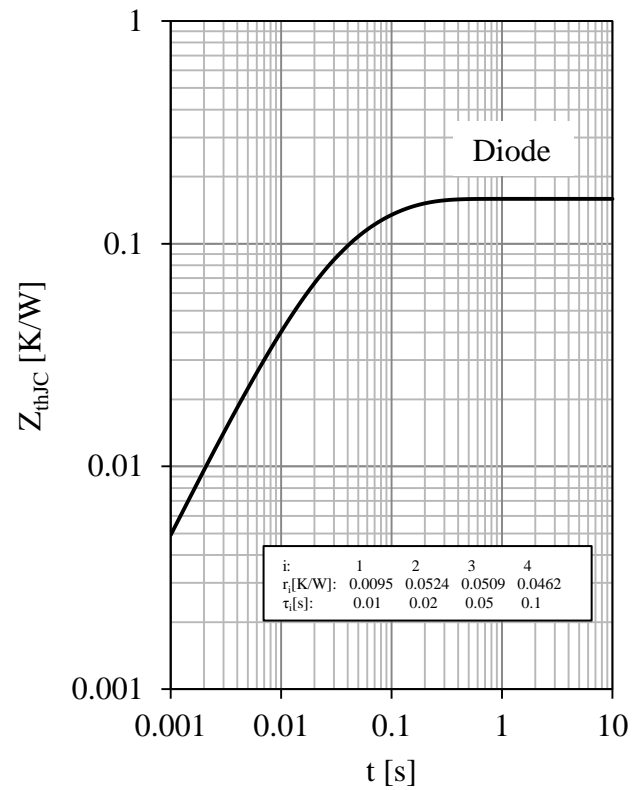
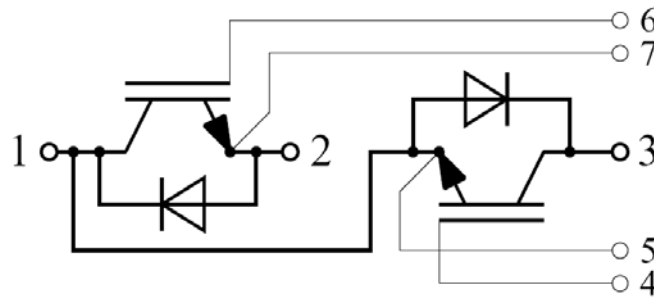
Fig 9. Diode Switching Loss vs.  $R_G$ 

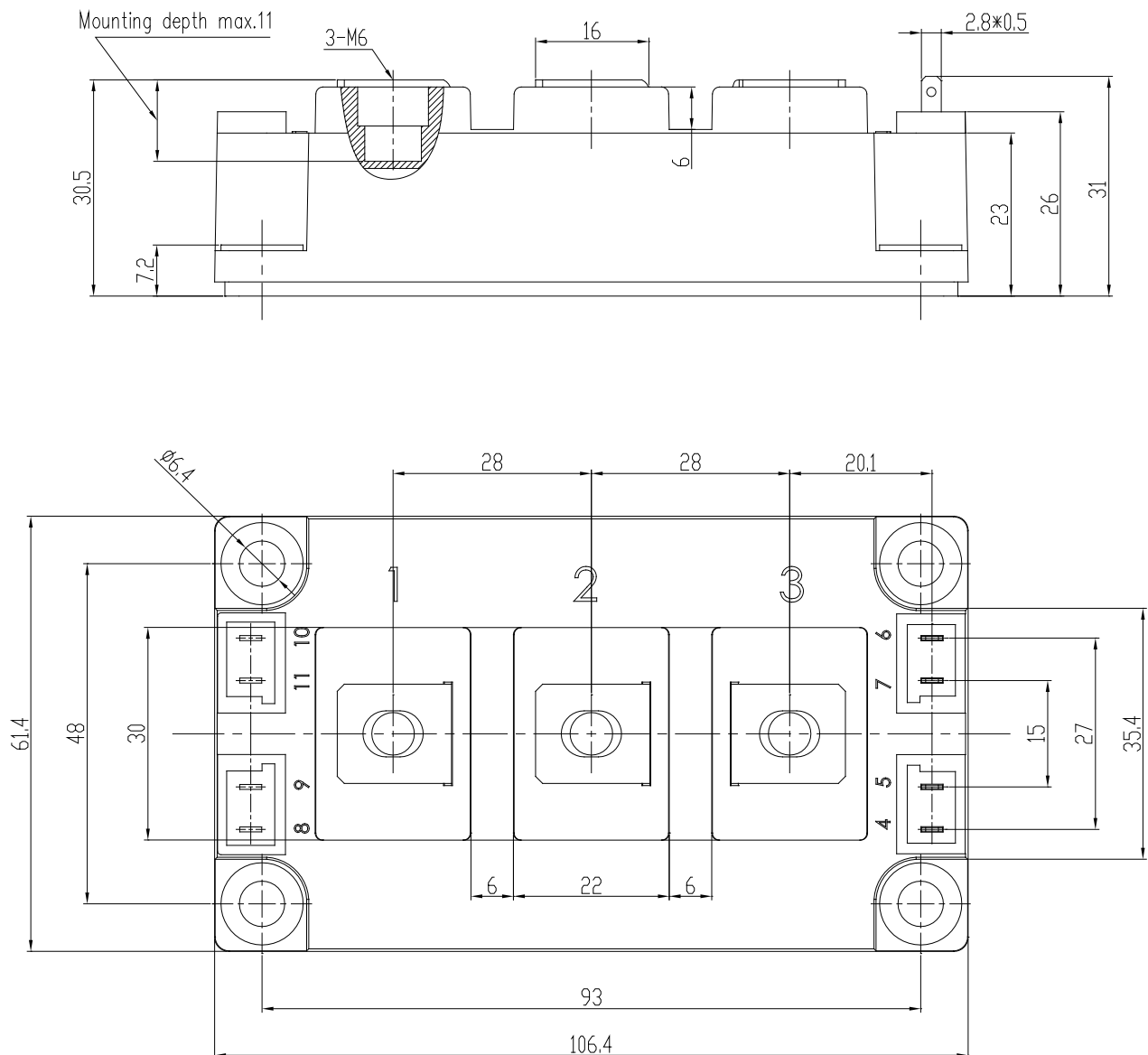
Fig 10. Diode Transient Thermal Impedance

## Circuit Schematic



## Package Dimensions

Dimensions in Millimeters





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